## Epoxies, Ect. 20-3035 (Cat.190)

Epoxy; Epoxide

Epoxies, Etc.

## Message:

20-3035 is a low density, two component epoxy potting and encapsulating system. The 20-3035 is less than half the weight of most commercially available potting compounds.

20-3035 exhibits very low shrinkage during the cure cycle and also has a low coefficient of thermal expansion. This unique epoxy system is an ideal material for the potting of electronic assemblies where a low dielectric constant and low weight are required.

This epoxy syntactic foam system utilizes an advanced micro balloon technology filler. The 20-3035 provides high strength and stiffness, thermal and environmental stability, creep resistance, and water resistance.

Features:

Low Dielectric Constant

General Information

Low Coefficient of Thermal Expansion

Low Shrinkage

Low Density

**Excellent Moisture Resistance** 

General Information			
Features	Good Creep Resistance		
	Good Thermal Stability		
	High Stiffness		
	High Strength		
	Low Density		
	Low Shrinkage		
	Low to No Water Absorption		
Uses	Electrical/Electronic Applications		
Processing Method	Encapsulating		
	Potting		
Physical	Nominal Value	Unit	
Molding Shrinkage - Flow	0.10	%	
Mechanical	Nominal Value	Unit	
Flexural Strength	48.3	MPa	
Thermal	Nominal Value	Unit	
CLTE - Flow	4.3E-5	cm/cm/°C	
Thermal Conductivity	0.19	W/m/K	
Thermoset	Nominal Value	Unit	
Thermoset Mix Viscosity (25°C)	25000	cP	
Additional Information	Nominal Value	Unit	
Operating Temperature	-40.0 to 130	°C	
Outgassing			
% CVCM	0.0600		
% TMLV	0.460		

Uncured Properties	Nominal Value	Unit	
Mix Ratio by Weight (PBW)			
Part A	100		
Part B	11		
Density (25°C)	0.818	g/cm³	
Viscosity <sup>1</sup> (25°C)	45	Pa·s	
Curing Time			
65°C	1.0 to 2.0	hr	
45°C	4.0 to 6.0	hr	
25°C	16 to 24	hr	
Pot Life <sup>2</sup> (25°C)	45	min	
Cured Properties	Nominal Value	Unit	
Water Absorption <sup>3</sup>	0.13	%	
Shore Hardness (Shore D)	80		
Tensile Strength	20.7	MPa	
Compression Strength	82.7	MPa	
Electric Strength	15	kV/mm	
Relative Permittivity (1 MHz)	2.70		
Volume Resistivity (25°C)	> 1.0E+13	ohms·cm	
Dissipation Factor (1 MHz)	0.050		
NOTE			
1.	Part A		
2.	100 grams		
3.	After 24 hours		

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